- **Function and Pinout Compatible With FCT** and F Logic
- Reduced V_{OH} (Typically = 3.3 V) Versions of Equivalent FCT Functions
- **Edge-Rate Control Circuitry for** Significantly Improved Noise **Characteristics**
- Ioff Supports Partial-Power-Down Mode • Operation
- **ESD Protection Exceeds JESD 22** - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- **Matched Rise and Fall Times**
- Fully Compatible With TTL Input and **Output Logic Levels**
- **3-State Outputs**
- **CY54FCT373T**
 - 32-mA Output Sink Current
 - 12-mA Output Source Current
- CY74FCT373T
 - 64-mA Output Sink Current
 - 32-mA Output Source Current

description

The 'FCT373T devices consist of eight latches with 3-state outputs for bus-organized applications. When the latch-enable (LE) input is high, the flip-flops appear transparent to the data. Data that meets the required setup times are latched when LE transitions from high to low. Data appears on the bus when the output-enable ($\overline{\mathsf{OE}}$) input is low. When OE is high, the bus output is in the high-impedance state. In this mode, data can be entered into the latches.

These devices are fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2001, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

| CY54FCT373T D PACKAGE |
|-----------------------------|
| CY74FCT373T Q OR SO PACKAGE |
| (TOP VIEW) |
| |

| OE | | O_{20} |]∨ _{cc} |
|----------------|------------|----------|------------------|
| 0 ₀ | 2 | 19 | 07 |
| D_0 | | 18 |] D ₇ |
| D ₁ | 4 | 17 |] D ₆ |
| 0 ₁ | [5 | 16 |] O ₆ |
| 0 ₂ | 6 | 15 |] O ₅ |
| D_2 | [7 | 14 |] D ₅ |
| D_3 | | 13 |] D ₄ |
| O3 | [9 | 12 | 04 |
| GND | | 11 | LE |

CY54FCT373T, CY74FCT373T 8-BIT LATCHES WITH 3-STATE OUTPUTS SCCS021B - MAY 1994 - REVISED OCTOBER 2001

| TA | PACI | (AGE [†] | SPEED (ns) | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | | | | |
|----------------|-----------|-------------------|---------------|--------------------------|---------------------|--|--|--|--|--|
| | QSOP – Q | Tape and reel | 4.7 | CY74FCT373CTQCT | FCT373C | | | | | |
| | SOIC – SO | Tube | 4.7 | CY74FCT373CTSOC | FCT373C | | | | | |
| | 5010 - 50 | Tape and reel | 4.7 | CY74FCT373CTSOCT | FU1373U | | | | | |
| –40°C to 85°C | QSOP – Q | Tape and reel | 5.2 | CY74FCT373ATQCT | FCT373A | | | | | |
| -40 C 10 85 C | SOIC – SO | Tube | 5.2 | CY74FCT373ATSOC | FCT373 | | | | | |
| | 3010 - 30 | Tape and reel | 5.2 | CY74FCT373ATSOCT | 1013/3 | | | | | |
| | SOIC – SO | Tube | 8 | CY74FCT373TSOC | FCT373 | | | | | |
| | 3010 - 30 | Tape and reel | 8 | CY74FCT373TSOCT | F01373 | | | | | |
| –55°C to 125°C | CDIP – D | Tube | 5.6 | CY54FCT373ATDMB | | | | | | |

ORDERING INFORMATION

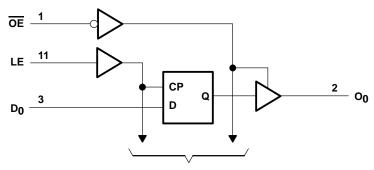
[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| | INPUTS | | OUTPUT |
|----|--------|---|----------------|
| OE | LE | D | 0 |
| L | Н | Н | н |
| L | н | L | L |
| L | L | Х | Q ₀ |
| н | Х | Х | Z |

H = High logic level, L = Low logic level, X = Don't care, Z = High-impedance state, Q_n = Previous state of flip flops (Q_{n-1})

logic diagram (positive logic)



To Seven Other Channels



SCCS021B - MAY 1994 - REVISED OCTOBER 2001

absolute maximum rating over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage range to ground potential | 0.5 V to 7 V |
|--|--------------------------|
| DC input voltage range | \ldots -0.5 V to 7 V |
| DC output voltage range | \ldots -0.5 V to 7 V |
| DC output current (maximum sink current/pin) | 120 mA |
| Package thermal impedance, θ_{JA} (see Note 1): Q package | 68°C/W |
| SO package | 58°C/W |
| Ambient temperature range with power applied, T _A | 65°C to 135°C |
| Storage temperature range, T _{stg} | 65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 2)

| | | CY54FCT373T | | | CY | '3T | UNIT | |
|-----|--------------------------------|-------------|-----|-----|------|-----|------|----|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| VCC | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| ЮН | High-level output current | | | -12 | | | -32 | mA |
| IOL | Low-level output current | | | 32 | | | 64 | mA |
| TA | Operating free-air temperature | -55 | | 125 | -40 | | 85 | °C |

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.



SCCS021B - MAY 1994 - REVISED OCTOBER 2001

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| BAR AMETER | TEST CONDITIONS | | CY | 54FCT37 | 73T | CY | 74FCT37 | ′3T | | |
|---|--|-----------------------------------|--------------------|------------------|------|-----|---------|-------------------------------|----------------------------|--|
| PARAMETER | IESI CC | DITIONS | MIN | TYP [†] | MAX | MIN | түр† | MAX | UNIT | |
| Maria | $V_{CC} = 4.5 \text{ V}, \qquad I_{IN} = -18 \text{ r}$ | nA | | -0.7 | -1.2 | | | | v | |
| VIK | $V_{CC} = 4.75 \text{ V}, \qquad I_{IN} = -18 \text{ r}$ | nA | | | | | -0.7 | YPT MAX -0.7 -1.2 3.3 | v | |
| | $V_{CC} = 4.5 V$, $I_{OH} = -12$ | mA | 2.4 | 3.3 | | | | | | |
| VOH | $V_{CC} = 4.75 V$ $I_{OH} = -32$ | mA | | | | 2 | | | V | |
| | $I_{OH} = -15$ | mA | | | | 2.4 | 3.3 | | | |
| Ve | $V_{CC} = 4.5 V$, $I_{OL} = 32 m$ | ۱A | | 0.3 | 0.55 | | | | v | |
| VOL | $V_{CC} = 4.75 \text{ V}, I_{OL} = 64 \text{ m}$ | ۱A | | | | | 0.3 | 0.55 | v | |
| V _{hys} | All inputs | | | 0.2 | | | 0.2 | | V | |
| | $V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = V_{CC}$ | <u>,</u> | | | 5 | | | | μA | |
| η η | $V_{CC} = 5.25 \text{ V}, V_{IN} = V_{CC}$ | , , | | | | | | 5 | | |
| hu i | $V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 2.7 \text{ V}$ | V | | | ±1 | | | | υA | |
| ΠΗ | $V_{CC} = 5.25 \text{ V}, V_{IN} = 2.7 \text{ V}$ | V | | | | | | ±1 | μΛ | |
| | $V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 0.5 \text{ V}$ | V | | | ±1 | | | | | |
| ΊL | $V_{CC} = 5.25 \text{ V}, V_{IN} = 0.5 \text{ V}$ | V | | | | | | ±1 | μΛ | |
| | V _{CC} = 5.5 V, V _{OUT} = 2. | 7 V | | | 10 | | | | | |
| 102H | V _{CC} = 5.25 V, V _{OUT} = 2. | 7 V | | | | | | 10 | μΛ | |
| 1071 | V _{CC} = 5.5 V, V _{OUT} = 0. | 5 V | | | -10 | | | | ıιΔ | |
| 'OZL | V _{CC} = 5.25 V, V _{OUT} = 0. | 5 V | | | | | | -10 | μΛ | |
| loot | $V_{CC} = 5.5 V, V_{OUT} = 0$ | V | -60 | -120 | -225 | | | | mΔ | |
| 105+ | V _{CC} = 5.25 V, V _{OUT} = 0 | V | | | | -60 | -120 | -225 | Αμ Αμ Αμ Αμ Αμ | |
| l _{off} | V _{CC} = 0 V, V _{OUT} = 4. | 5 V | | | ±1 | | | ±1 | μA | |
| | $V_{CC} = 5.5 \text{ V}, \qquad V_{IN} \le 0.2 \text{ V}$ | $V_{\rm IN} \ge V_{\rm CC} - 0.2$ | / | 0.1 | 0.2 | | | | m۵ | |
| 100 | | $V_{\rm IN} \ge V_{\rm CC} - 0.2$ | / | | | | 0.1 | 0.2 | | |
| Alco | V_{CC} = 5.5 V, V_{IN} = 3.4 V§, f | | Outputs open 0.5 2 | | | | | m۵ | | |
| IIL IOZH IOZL IOS [‡] | $V_{CC} = 5.25 \text{ V}, \text{ V}_{IN} = 3.4 \text{ V}\$,$ | f ₁ = 0, Outputs open | | | | | 0.5 | 2 | IIIA | |

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

* Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, IOS tests should be performed last.

§ Per TTL-driven input (V_{IN} = 3.4 V); all other inputs at V_{CC} or GND



SCCS021B - MAY 1994 - REVISED OCTOBER 2001

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

| PARAMETER | | TEST CONDITION | 6 | CY | 54FCT3 | 73T | CY | 74FCT37 | ′3T | |
|--|--|---|---------------------------------|----|--|------|-----|---------|--------------------|-----|
| PARAMETER | TEST CONDITIONS | | | | $\begin{array}{c c c c c c c c c c c c c c c c c c c $ | UNIT | | | | |
| ICCD | | | OE = GND, | | 0.06 | 0.12 | | | | mA/ |
| "CCD" | One input switch | $V_{CC} = 5.25 \text{ V}, \text{ Outputs open,}$ One input switching at 50% duty cycle, $\overline{\text{OE}} = \text{GND},$ $V_{IN} \le 0.2 \text{ V or } V_{IN} \ge V_{CC} - 0.2 \text{ V}$ | | | | | | 0.06 | 0.12 | MHz |
| | V _{CC} = 5.5 V, | One bit switching at f ₁ = 10 MHz | | | 0.7 | 1.4 | | | | |
| | $\frac{Outputs open,}{OE} = GND,$ LE = V _{CC} | Outputs open, at 50% duty cycle | $V_{IN} = 3.4 \text{ V or GND}$ | | 1 | 2.4 | | | | |
| | | Eight bits switching at $f_1 = 2.5$ MHz | | | 1.3 | 2.6 | | | | |
| 1# | | at 50% duty cycle | $V_{IN} = 3.4 \text{ V or GND}$ | | 3.3 | 10.6 | | | | ~ ^ |
| IC., | Voo - 5 25 V | One bit switching at $f_1 = 10 \text{ MHz}$ | | | | | | 0.7 | 1.4 | ma |
| $IC^{\#} \qquad \begin{array}{ c c c c c } \hline \overline{OE} = GND, \\ LE = VCC & at 50\% \ duty \ cycle & VIN \leq 0.2 \ Vole \\ at f_1 = 2.5 \ MHz \\ at 50\% \ duty \ cycle & VIN \geq VCC - \\ \hline VIN = 3.4 \ Vole \\ VIN \geq VCC - \\ \hline VIN \geq 0.2 \ Vole \ Vole \\ \hline VIN \geq 0.2 \ Vole \\ \hline VIN \geq 0.2 \ Vole \\ \hline VIN \geq 0.2 \ Vole \ Vole \ Vole \ Vole \\ $ | at 50% duty cycle | $V_{IN} = 3.4 \text{ V or GND}$ | | | | | 1 | 2.4 | | |
| | $\begin{array}{l} V_{IN} \leq 0.2 \ V \ or \\ V_{IN} \geq V_{CC} - 0.2 \ V \end{array} \end{array} \label{eq:VIN}$ | | | | | 1.3 | 2.6 | | | |
| | | at 50% duty cycle | $V_{IN} = 3.4 \text{ V or GND}$ | | | | | 3.3 | 10.6 | |
| Ci | | | | | 6 | 10 | | 6 | 10 | pF |
| Co | | | | | 8 | 12 | | 8 | 12 | pF |

Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

This parameter is derived for use in total power-supply calculations.

[#] IC = ICC + Δ ICC × D_H × N_T + ICCD (f₀/2 + f₁ × N₁)

- Where:
- $I_C = \mbox{Total supply current} \\ I_{CC} = \mbox{Power-supply current with CMOS input levels}$
- ΔI_{CC} = Power-supply current for a TTL high input (V_{IN} = 3.4 V)

 D_H = Duty cycle for TTL inputs high NT = Number of TTL inputs at D_H

- I_{CCD} = Dynamic current caused by an input transition pair (HLH or LHL)

= Clock frequency for registered devices, otherwise zero f₀

- f1 = Input signal frequency
- = Number of inputs changing at f1 N_1

All currents are in milliamperes and all frequencies are in megahertz.

Il Values for these conditions are examples of the I_{CC} formula.



SCCS021B - MAY 1994 - REVISED OCTOBER 2001

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | CY54FC | T373T | CY54FCT | UNIT | |
|-----------------|-----------------------------|--------|-------|---------|------|------|
| | | MIN | MAX | MIN | MAX | UNIT |
| tw | Pulse duration, LE high | 6 | | 6 | | ns |
| t _{su} | Setup time, data before LE1 | 2 | | 2 | | ns |
| th | Hold time, data after LE↑ | 1.5 | | 1.5 | | ns |

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| | | CY74FCT373T | | CY74FCT | 373AT | CY74FCT | UNIT | |
|-----------------|-----------------------------|-------------|-----|---------|-------|---------|------|------|
| | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| tw | Pulse duration, LE high | 6 | | 5 | | 5 | | ns |
| t _{su} | Setup time, data before LE↑ | 2 | | 2 | | 2 | | ns |
| th | Hold time, data after LE↑ | 1.5 | | 1.5 | | 1.5 | | ns |

switching characteristics over operating free-air temperature range (see Figure 1)

| PARAMETER | FROM | то | CY54FCT | UNIT | |
|------------------|---------|----------|---------|------|-----|
| FARAMETER | (INPUT) | (OUTPUT) | MIN | MAX | |
| ^t PLH | D | 0 | 1.5 | 5.6 | ns |
| ^t PHL | U | 0 | 1.5 | 5.6 | 115 |
| ^t PLH | LE | 0 | 2 | 9.8 | ns |
| ^t PHL | | 0 | 2 | 9.8 | 115 |
| ^t PZH | OE | 0 | 1.5 | 7.5 | 200 |
| ^t PZL | ŬE. | 0 | 1.5 | 7.5 | ns |
| ^t PHZ | OE | 0 | 1.5 | 6.5 | 200 |
| ^t PLZ | ŬE. | 0 | 1.5 | 6.5 | ns |

switching characteristics over operating free-air temperature range (see Figure 1)

| PARAMETER | FROM | то | CY74FC | T373T | CY74FCT | 373AT | CY74FCT | Г373CT | UNIT |
|------------------|---------|----------|--------|-------|---------|-------|---------|--------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | |
| ^t PLH | D | О | 1.5 | 8 | 1.5 | 5.2 | 1.5 | 4.7 | |
| ^t PHL | | 0 | 1.5 | 8 | 1.5 | 5.2 | 1.5 | 4.7 | ns |
| ^t PLH | LE | 0 | 2 | 13 | 2 | 8.5 | 2 | 5.5 | |
| ^t PHL | | 0 | 2 | 13 | 2 | 8.5 | 2 | 5.5 | ns |
| ^t PZH | OE | 0 | 1.5 | 12 | 1.5 | 6.5 | 1.5 | 5.5 | ns |
| ^t PZL | ÜE | 0 | 1.5 | 12 | 1.5 | 6.5 | 1.5 | 5.5 | 115 |
| ^t PHZ | OE | 0 | 1.5 | 7.5 | 1.5 | 5.5 | 1.5 | 5 | ns |
| ^t PLZ | UE | 0 | 1.5 | 7.5 | 1.5 | 5.5 | 1.5 | 5 | 115 |



07V **S1** O Open **500** Ω From Output From Output Test $\Lambda \Lambda \Lambda$ TEST O GND **S1** Under Test **Under Test** Point tPLH/tPHL Open C_L = 50 pF $C_1 = 50 \text{ pF}$ 2 **500** Ω **500** Ω 7 V (see Note A) tPLZ/tPZL (see Note A) tPHZ/tPZH Open LOAD CIRCUIT FOR LOAD CIRCUIT FOR **TOTEM-POLE OUTPUTS 3-STATE OUTPUTS** 3 V **Timing Input** 1.5 V 0 V tw th 3 V tsu 3 V 1.5 V 1.5 V Input 1.5 V 1.5 V **Data Input** 0 V 0 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS** PULSE DURATION SETUP AND HOLD TIMES 3 V 3 V Output 1.5 V 1.5 V 1.5 V 1.5 V Input Control 0 V 0 V -t_{PLZ} ^tPLH ^tPHL tPZL -┢ ۷он Output ≈3.5 V In-Phase 1.5 V 1.5 V Waveform 1 .5 V Output /_{OL} + 0.3 V (see Note B) VOL VOL ^tPHL Κ ^tPLH ^tPZH ^tPHZ ۷он Output ۷он **Out-of-Phase** VOH – 0.3 V 1.5 V 1.5 V Waveform 2 5 V Output (see Note B) ≈0 V VOL **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES** ENABLE AND DISABLE TIMES INVERTING AND NONINVERTING OUTPUTS LOW- AND HIGH-LEVEL ENABLING

PARAMETER MEASUREMENT INFORMATION

NOTES: A. C₁ includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





9-Mar-2021

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|-------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|--|---------|
| 5962-9221701MRA | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9221701MR A | Samples |
| 5962-9221702MRA | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9221702MR A CY54FCT373ATDM B | Samples |
| 5962-9221703M2A | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 9221703M2A | Samples |
| CY54FCT373ATDMB | ACTIVE | CDIP | J | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9221702MR A CY54FCT373ATDM B | Samples |
| CY74FCT373ATQCT | ACTIVE | SSOP | DBQ | 20 | 2500 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT373A | Samples |
| CY74FCT373ATQCTE4 | ACTIVE | SSOP | DBQ | 20 | 2500 | RoHS & Green | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | FCT373A | Samples |
| CY74FCT373ATSOC | ACTIVE | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT373A | Samples |
| CY74FCT373TSOC | ACTIVE | SOIC | DW | 20 | 25 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | FCT373 | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



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9-Mar-2021

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | | Package Drawing | Pins | | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| CY74FCT373ATQCT | SSOP | DBQ | 20 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

5-Jan-2022



*All dimensions are nominal

| Device | evice Package Type | | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) | |
|-----------------|--------------------|-----|------|------|-------------|------------|-------------|--|
| CY74FCT373ATQCT | SSOP | DBQ | 20 | 2500 | 853.0 | 449.0 | 35.0 | |



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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9221703M2A | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| CY74FCT373ATSOC | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| CY74FCT373TSOC | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |

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